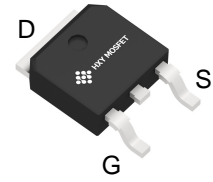




Description

The HXY30N10D uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.



TO-252-2L

General Features

$V_{DS} = 100V$ $I_D = 30A$

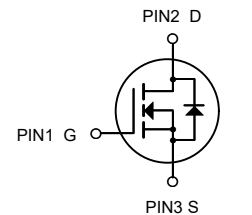
$R_{DS(ON)} < 43m\Omega$ @ $V_{GS}=10V$

Application

Battery protection

Load switch

Uninterruptible power supply



N-Channel MOSFET

Ordering Information

| Product ID | Pack | Brand | Qty(PCS) |
|------------|----------|------------|----------|
| HXY30N10D | TO252-2L | HXY MOSFET | 2500 |

Absolute Maximum Ratings $T_C=25^\circ C$ unless otherwise noted

| Symbol | Parameter | Rating | Units |
|-----------------------|--|------------|--------------|
| V_{DS} | Drain-Source Voltage | 100 | V |
| V_{GS} | Gate-Source Voltage | ± 20 | V |
| $I_D@T_C=25^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V^1$ | 30 | A |
| $I_D@T_C=100^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V^1$ | 13.5 | A |
| $I_D@T_A=25^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V^1$ | 4.2 | A |
| $I_D@T_A=70^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V^1$ | 3.4 | A |
| I_{DM} | Pulsed Drain Current ² | 45 | A |
| EAS | Single Pulse Avalanche Energy ³ | 36.5 | mJ |
| I_{AS} | Avalanche Current | 27 | A |
| $P_D@T_C=25^\circ C$ | Total Power Dissipation ⁴ | 52.1 | W |
| $P_D@T_A=25^\circ C$ | Total Power Dissipation ⁴ | 2 | W |
| T_{STG} | Storage Temperature Range | -55 to 150 | $^\circ C$ |
| T_J | Operating Junction Temperature Range | -55 to 150 | $^\circ C$ |
| $R_{\theta JA}$ | Thermal Resistance Junction-ambient ¹ | 62 | $^\circ C/W$ |
| $R_{\theta JC}$ | Thermal Resistance Junction-Case ¹ | 2.4 | $^\circ C/W$ |



Electrical Characteristics (T_c=25°C unless otherwise noted)

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|-------------------------------------|--|--|------|-------|------|-------|
| BV _{DSS} | Drain-Source Breakdown Voltage | V _{GS} =0V, I _D =250uA | 100 | --- | --- | V |
| ΔBV _{DSS} /ΔT _J | BVDSS Temperature Coefficient | Reference to 25°C, I _D =1mA | --- | 0.098 | --- | V/°C |
| R _{DS(on)} | Static Drain-Source On-Resistance ² | V _{GS} =10V, I _D =20A | --- | 35 | 43 | mΩ |
| | | V _{GS} =4.5V, I _D =15A | --- | 40 | 50 | |
| V _{GS(th)} | Gate Threshold Voltage | | 1.3 | --- | 2.5 | V |
| ΔV _{GS(th)} | V _{GS(th)} Temperature Coefficient | V _{GS} =V _{DS} , I _D =250uA | --- | -5.52 | --- | mV/°C |
| I _{DSS} | Drain-Source Leakage Current | V _{DS} =80V, V _{GS} =0V, T _J =25°C | --- | --- | 10 | uA |
| | | V _{DS} =80V, V _{GS} =0V, T _J =55°C | --- | --- | 100 | |
| I _{GSS} | Gate-Source Leakage Current | V _{GS} =±20V, V _{DS} =0V | --- | --- | ±100 | nA |
| g _{fs} | Forward Transconductance | V _{DS} =5V, I _D =20A | --- | 28.7 | --- | S |
| R _g | Gate Resistance | V _{DS} =0V, V _{GS} =0V, f=1MHz | --- | 1.6 | 3.2 | Ω |
| Q _g | Total Gate Charge (10V) | | --- | 60 | 84 | nC |
| Q _{gs} | Gate-Source Charge | V _{DS} =80V, V _{GS} =10V, I _D =20A | --- | 9.7 | 14 | |
| Q _{gd} | Gate-Drain Charge | | --- | 11.8 | 16.5 | |
| T _{d(on)} | Turn-On Delay Time | | --- | 10.4 | 21 | ns |
| T _r | Rise Time | V _{DD} =50V, V _{GS} =10V, R _G =3.3Ω | --- | 46 | 83 | |
| T _{d(off)} | Turn-Off Delay Time | I _D =20A | --- | 54 | 108 | |
| T _f | Fall Time | | --- | 10 | 20 | |
| C _{iss} | Input Capacitance | | --- | 3848 | 5387 | pF |
| C _{oss} | Output Capacitance | V _{DS} =15V, V _{GS} =0V, f=1MHz | --- | 137 | 192 | |
| C _{rss} | Reverse Transfer Capacitance | | --- | 82 | 115 | |
| I _S | Continuous Source Current ^{1,5} | | --- | --- | 22 | A |
| I _{SM} | Pulsed Source Current ^{2,5} | V _G =V _D =0V, Force Current | --- | --- | 45 | A |
| V _{SD} | Diode Forward Voltage ² | V _{GS} =0V, I _S =1A, T _J =25°C | --- | --- | 1.2 | V |
| t _{rr} | Reverse Recovery Time | I _F =20A, dI/dt=100A/μs, T _J =25°C | --- | 30 | --- | nS |
| Q _{rr} | Reverse Recovery Charge | | --- | 37 | --- | nC |

Note :

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%
- 3.The EAS data shows Max. rating . The test condition is V_{DD}=25V, V_{GS}=10V, L=0.1mH, I_{AS}=27A
- 4.The power dissipation is limited by 150°C junction temperature
- 5.The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.



Typical Characteristics

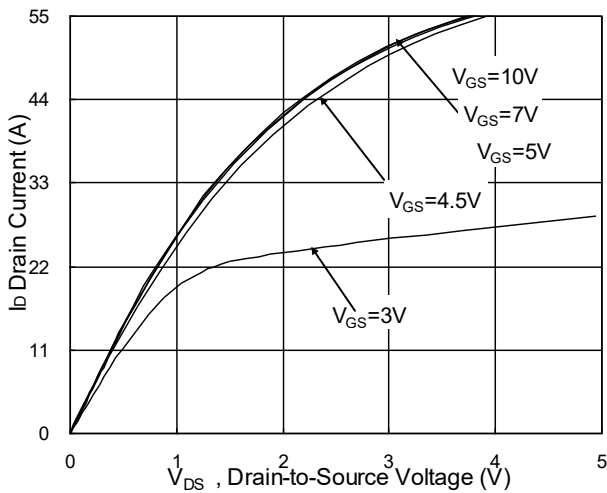


Fig.1 Typical Output Characteristics

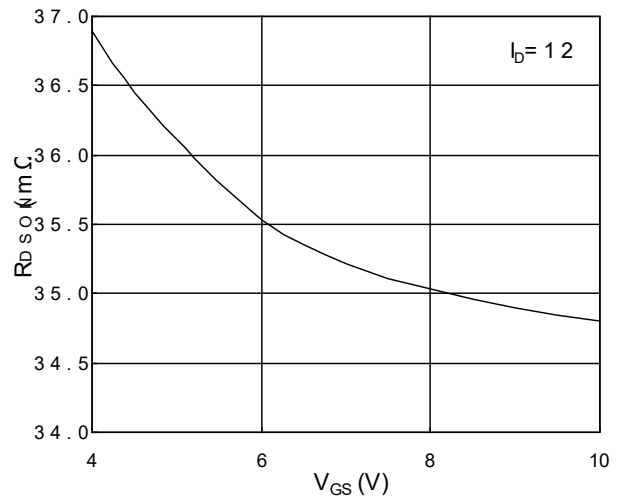


Fig.2 On-Resistance vs. Gate-Source

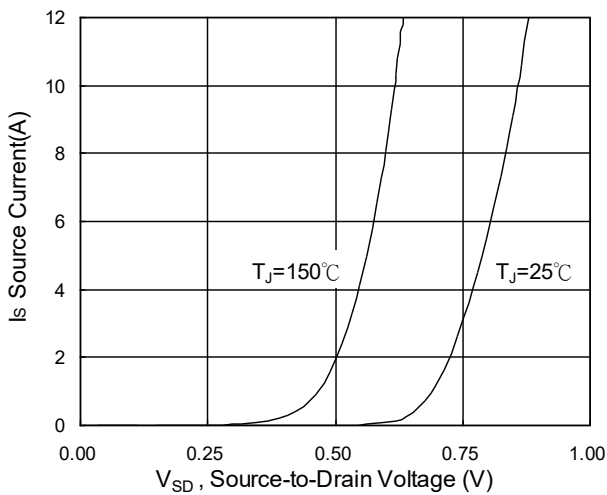


Fig.3 Forward Characteristics Of Reverse

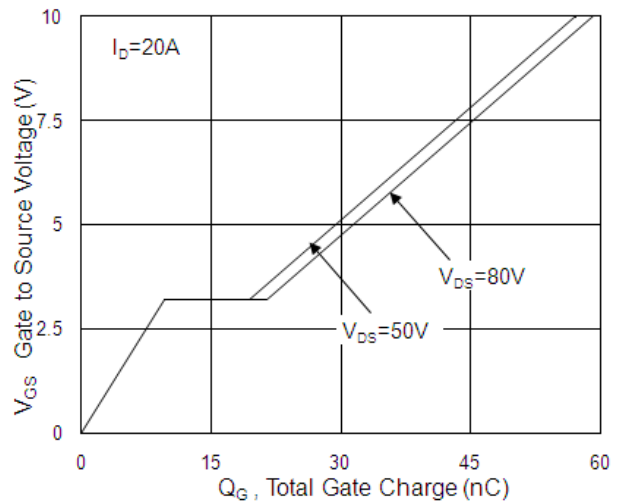


Fig.4 Gate-Charge Characteristics

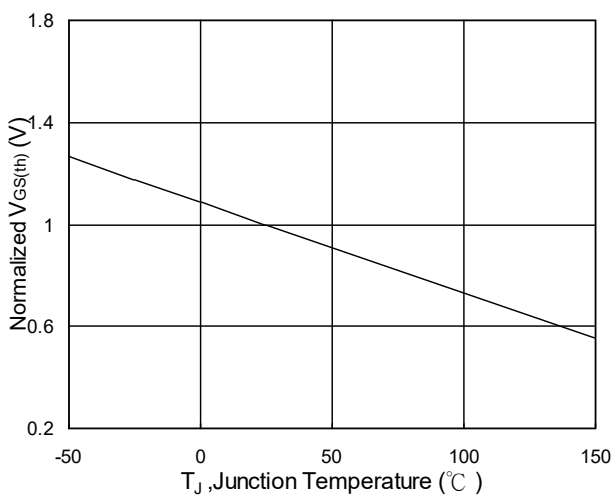


Fig.5 Normalized V_{GS(th)} vs. T_J

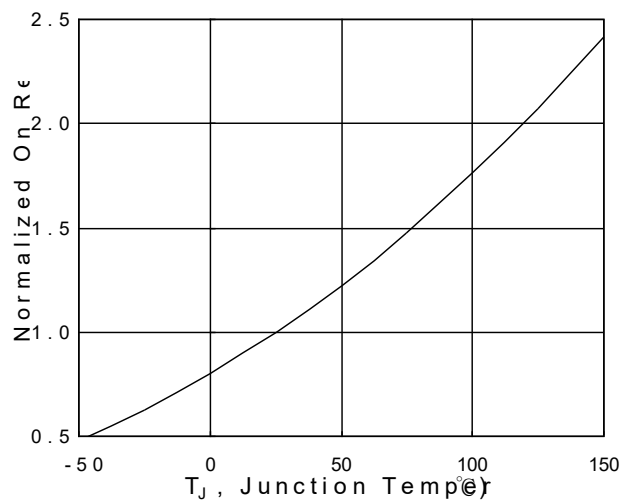


Fig.6 Normalized R_{DS(on)} vs. T_J

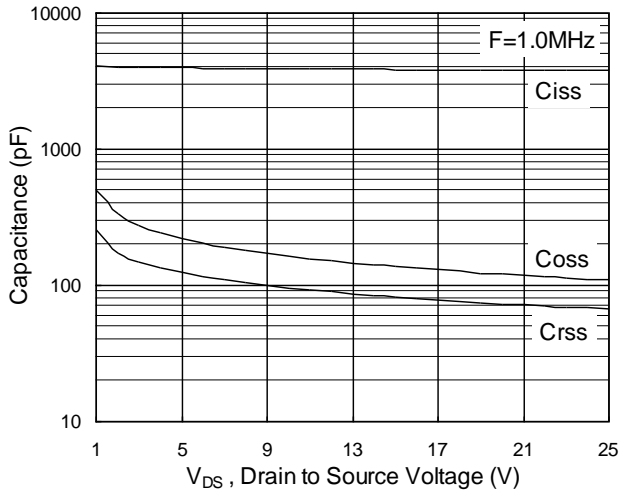


Fig.7 Capacitance

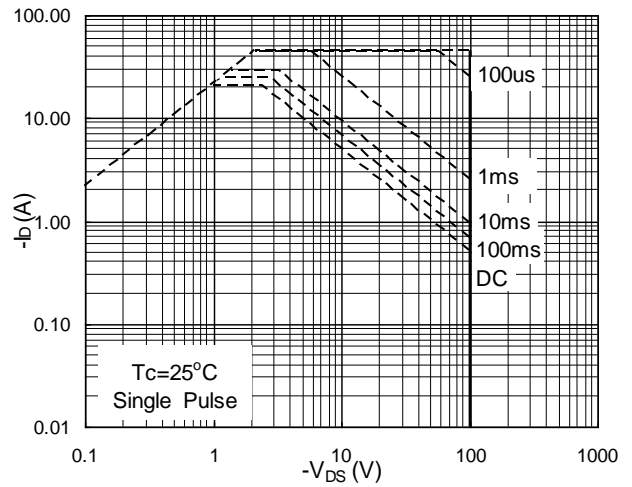


Fig.8 Safe Operating Area

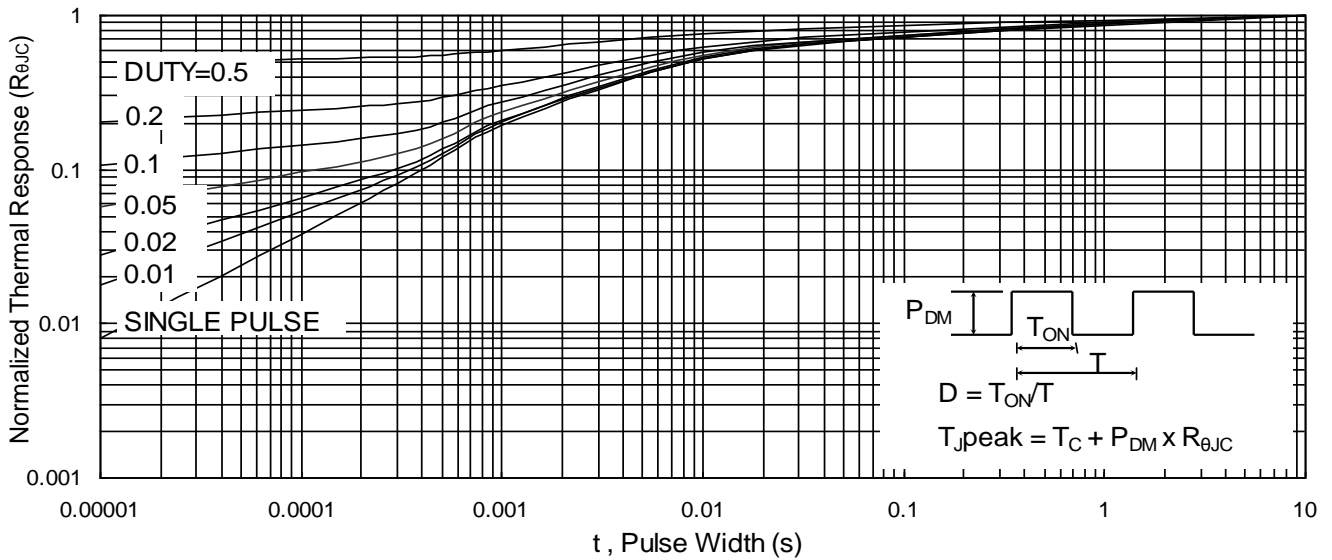


Fig.9 Normalized Maximum Transient Thermal Impedance

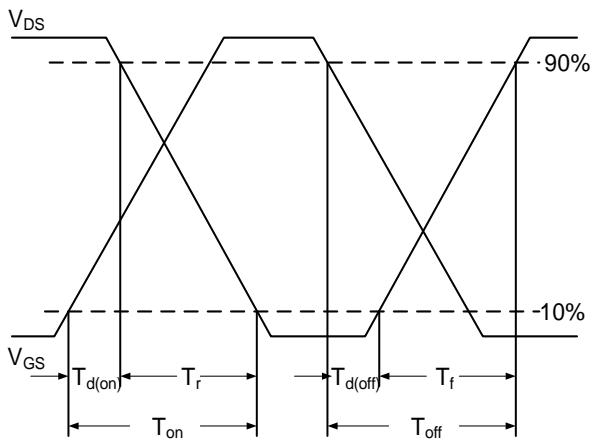


Fig.10 Switching Time Waveform

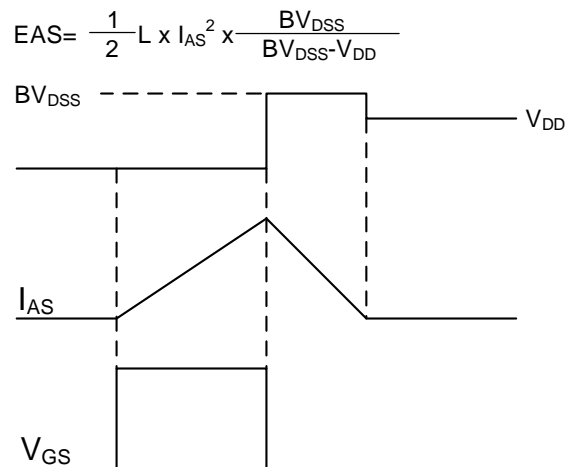


Fig.11 Unclamped Inductive Switching Waveform



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